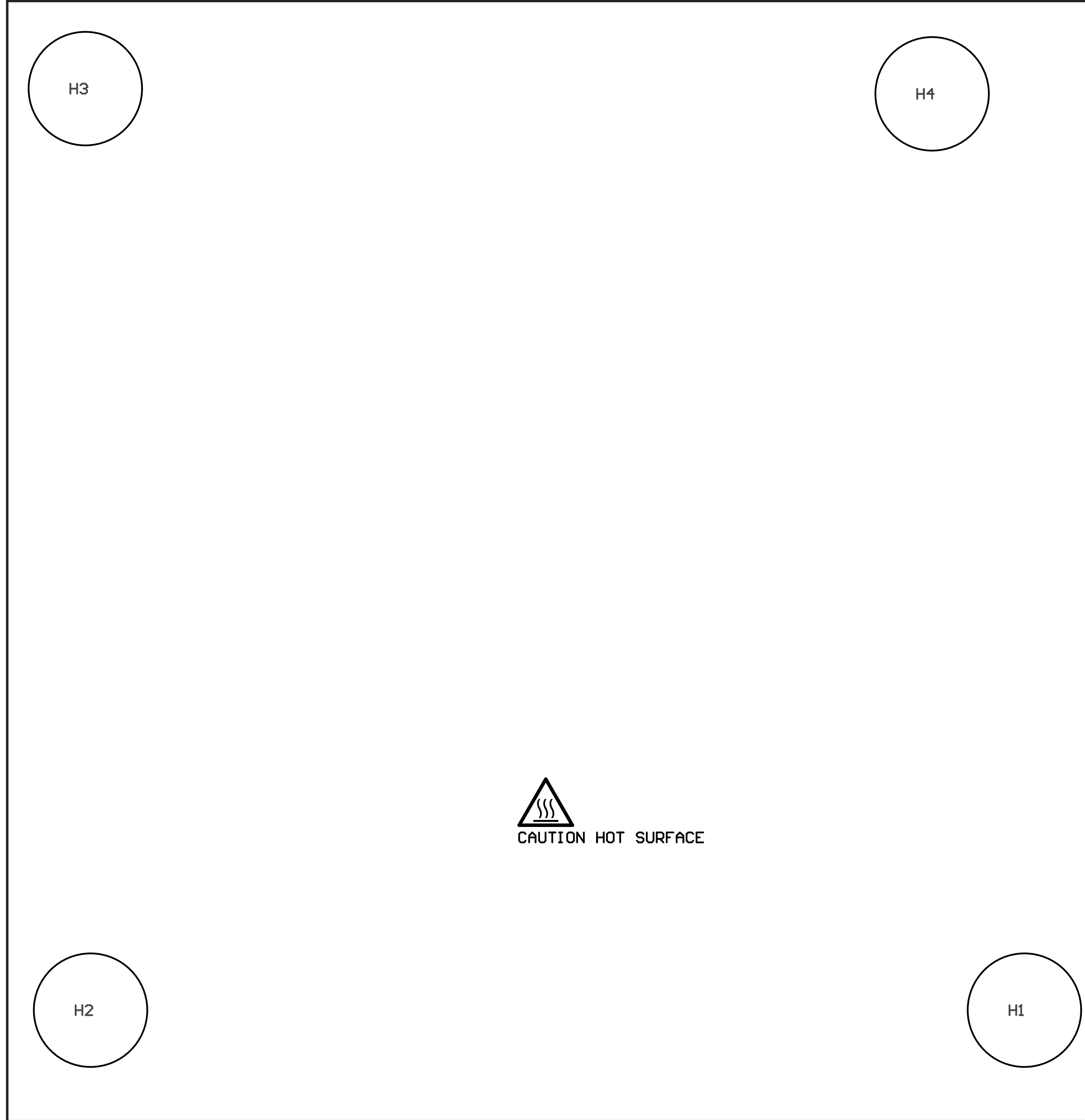


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: TIDA-00449

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00449	REV: 3.3	SUN REV: Not In VersionControl
MpbOverl@yline			
PLOT NAME = Top Layer Assembly Drawing	GENERATED : 9/24/2015	2:37:16 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: TIDA-00449

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00449	REV: 3.3	SUN REV: Not In VersionControl
Bottom Layer Assembly Drawing			
PLOT NAME = Bottom Layer Assembly Drawing	GENERATED : 9/24/2015 2:37:21 PM		TEXAS INSTRUMENTS

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